



NEMNC018

Pb RoHS

## 30V 6 IN 1 N-Channel MOSFETs

## General Description

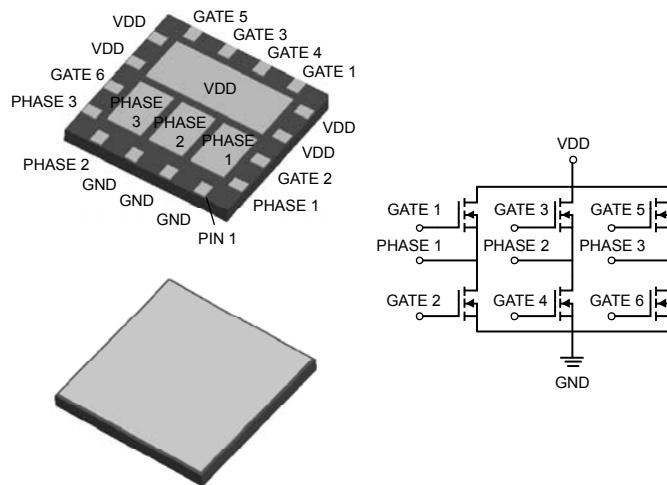
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

$BV_{DSS}$	$R_{DS(ON)}$	$I_D$
30 V	18 mΩ	23 A

## Features

- $R_{DS(ON)} \leq 18\text{m}\Omega @ V_{GS}=10\text{V}$
- Fast switching
- Improved dv/dt capability
- Green Device Available

DFN6X6 Pin Configuration



## Applications

- 3-PHASE Applications

Absolute Maximum Ratings  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current - Continuous ( $T_C=25^\circ\text{C}$ )	23	A
	Drain Current - Continuous ( $T_C=100^\circ\text{C}$ )	14.5	A
$I_{DM}$	Drain Current - Pulsed (NOTE 1)	92	A
EAS	Single Pulse Avalanche Energy (NOTE 2)	18	mJ
IAS	Single Pulse Avalanche Current (NOTE 2)	19	A
$P_D$	Power Dissipation ( $T_C=25^\circ\text{C}$ )	15.4	W
	Power Dissipation - Derate above $25^\circ\text{C}$	0.12	W/ $^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-50 to 150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-50 to 150	$^\circ\text{C}$
Marking Code		NC018 , 3012HF6	

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	---	62	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	8.1	$^\circ\text{C/W}$



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Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

## Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	30	---	---	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=24\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$

## On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance (NOTE 3)	$V_{\text{GS}}=10\text{V}$ , $I_D=12\text{A}$	---	13.5	18	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_D=8\text{A}$	---	18.5	24	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D=250\mu\text{A}$	1.2	1.6	2.5	V
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_D=6\text{A}$	---	8	---	S

## Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$Q_g$	Total Gate Charge	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=10\text{A}$ (NOTE 3、4)	---	5.2	10	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	0.6	1.2	
$Q_{\text{gd}}$	Gate-Drain Charge		---	2	4	
$T_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_G=6\Omega$ , $I_D=1\text{A}$ (NOTE 3、4)	---	2.8	5	nS
$T_r$	Rise Time		---	7.2	14	
$T_{\text{d(off)}}$	Turn-Off Delay Time		---	15.8	30	
$T_f$	Fall Time		---	4.6	9	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	370	740	pF
$C_{\text{oss}}$	Output Capacitance		---	70	140	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	50	100	
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1\text{MHz}$	---	2.2	4.5	$\Omega$

## Drain-Source Diode Characteristics and Ratings

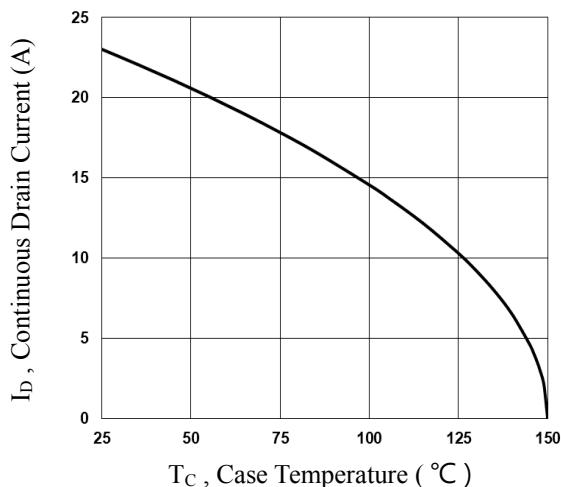
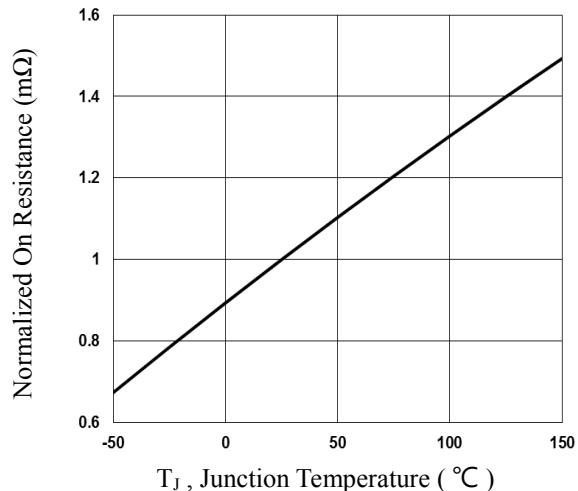
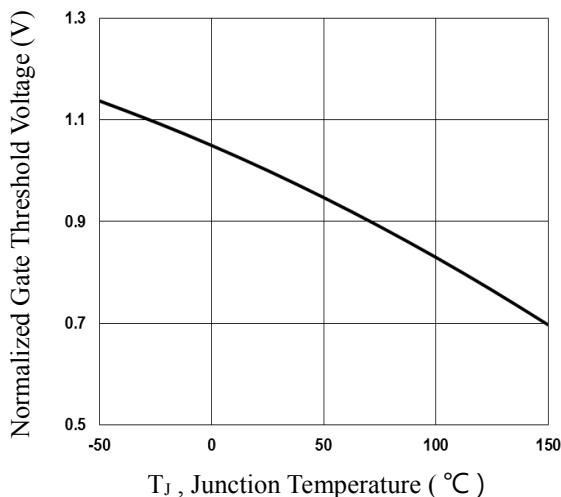
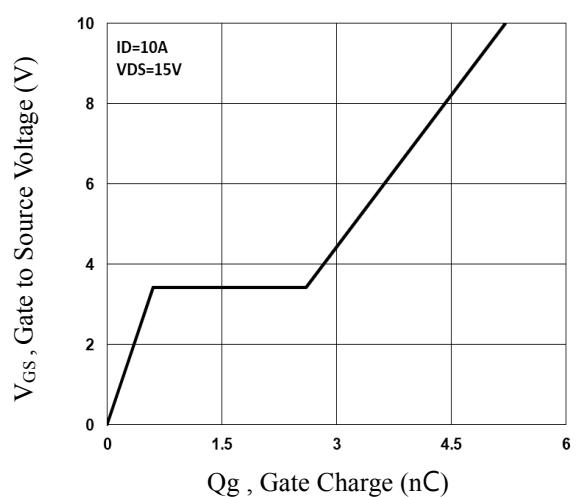
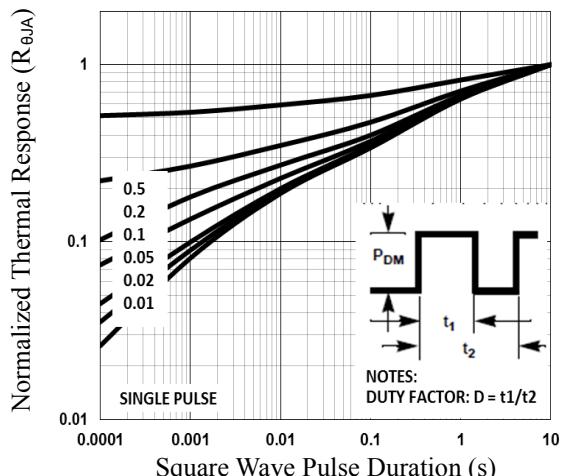
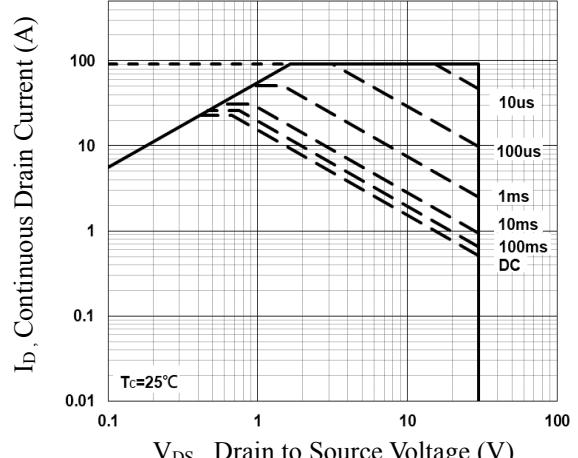
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	23	A
$I_{\text{SM}}$	Pulsed Source Current (NOTE 3)		---	---	46	A
$V_{\text{SD}}$	Diode Forward Voltage (NOTE 3)	$V_{\text{GS}}=0\text{V}$ , $I_S=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V

## NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=25\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=1\text{mH}$ ,  $I_{\text{AS}}=19\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.



## Characteristics Curves

**Fig.1 Continuous Drain Current vs. TC****Fig.2 Normalized RDS(on) vs. TJ****Fig.3 Normalized V<sub>th</sub> vs. TJ****Fig.4 Gate Charge Waveform****Fig.5 Normalized Transient Response****Fig.6 Maximum Safe Operation Area**



## Characteristics Curves

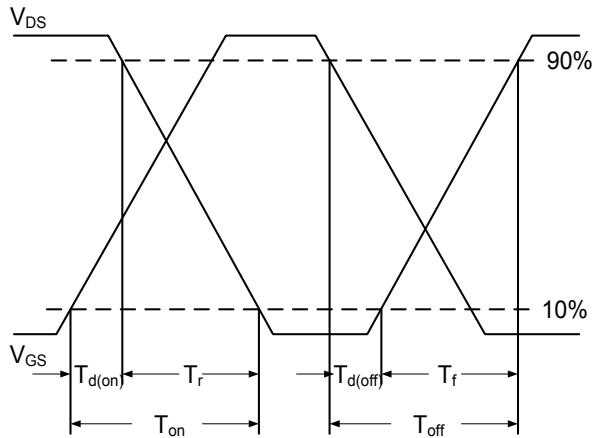


Fig.7 Switching Time Waveform

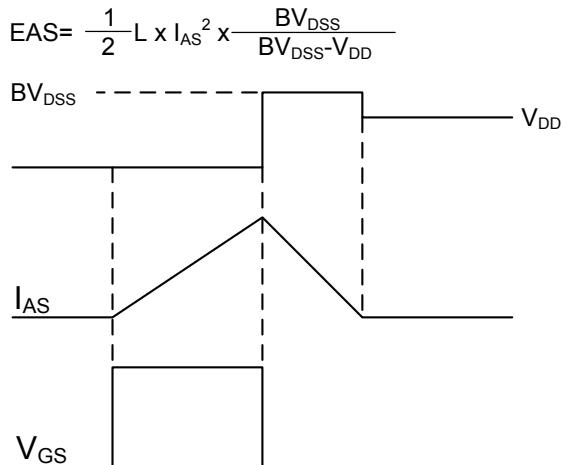
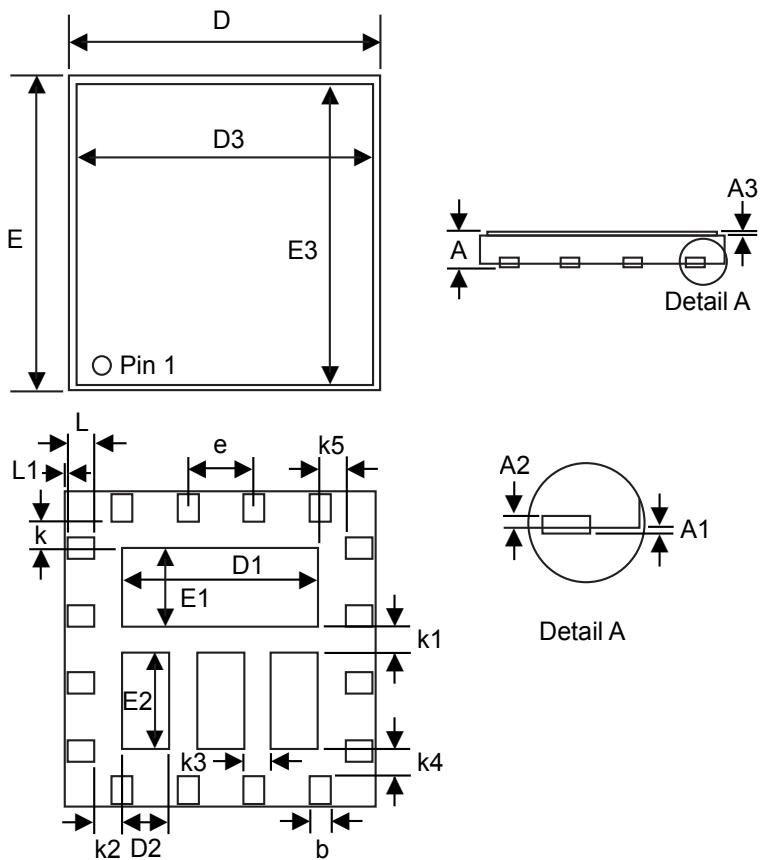


Fig.8 EAS Waveform

## Package Outline Dimensions



Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.53	0.60	0.02	0.024
A1	-	0.01	-	0.001
A2	0.03	0.10	0.001	0.004
A3	0.05	0.10	0.001	0.004
D	5.90	6.10	0.232	0.241
E	5.90	6.10	0.232	0.241
D1	3.70	3.90	0.145	0.154
E1	1.32	1.53	0.051	0.061
D2	0.80	1.00	0.031	0.04
E2	1.72	1.93	0.067	0.076
b	0.35	0.45	0.013	0.018
L	0.45	0.55	0.017	0.022
L1	0.01	0.09	0.001	0.004
k	0.55 Ref		0.022 Ref	
k1	0.55 Ref		0.022 Ref	
k2	0.55 Ref		0.022 Ref	
k3	0.55 Ref		0.022 Ref	
k4	0.55 Ref		0.022 Ref	
k5	0.55 Ref		0.022 Ref	
e	1.27 BSC		0.05 BSC	
D3	5.80 Ref		0.229 Ref	
E3	5.80 Ref		0.229 Ref	

DFN6X6



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